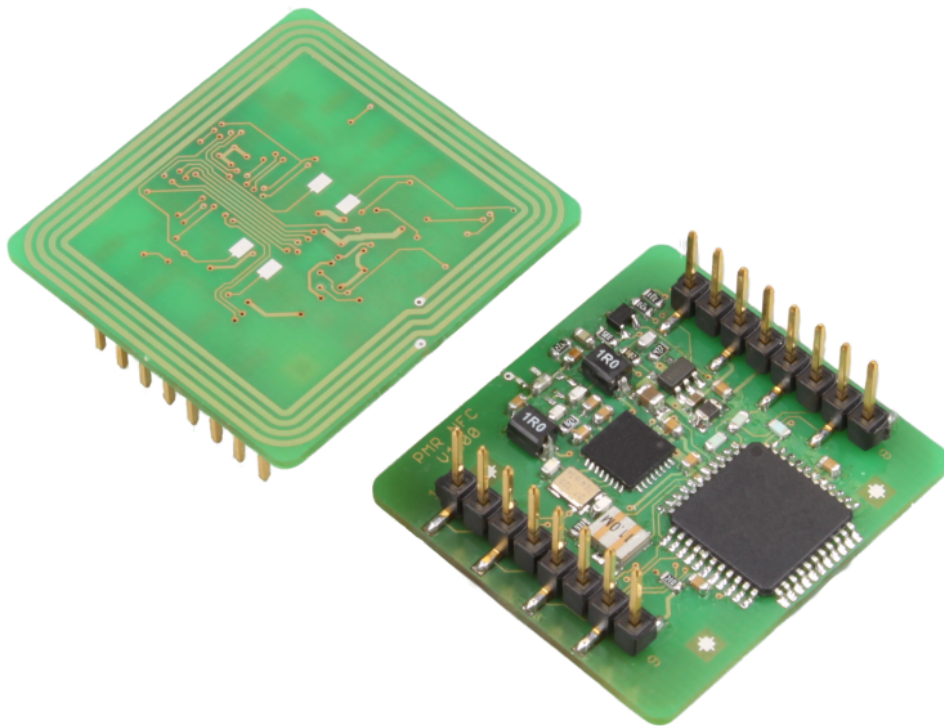


# TWN4

## MultiTech Mini

DocRev9, November 7, 2022



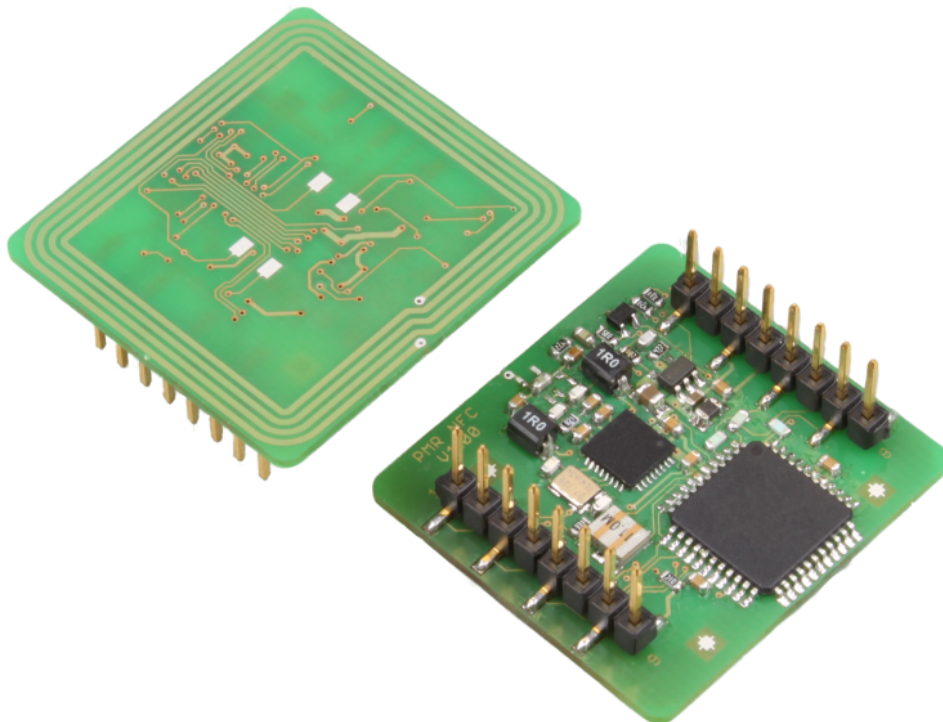
ELATEC GmbH

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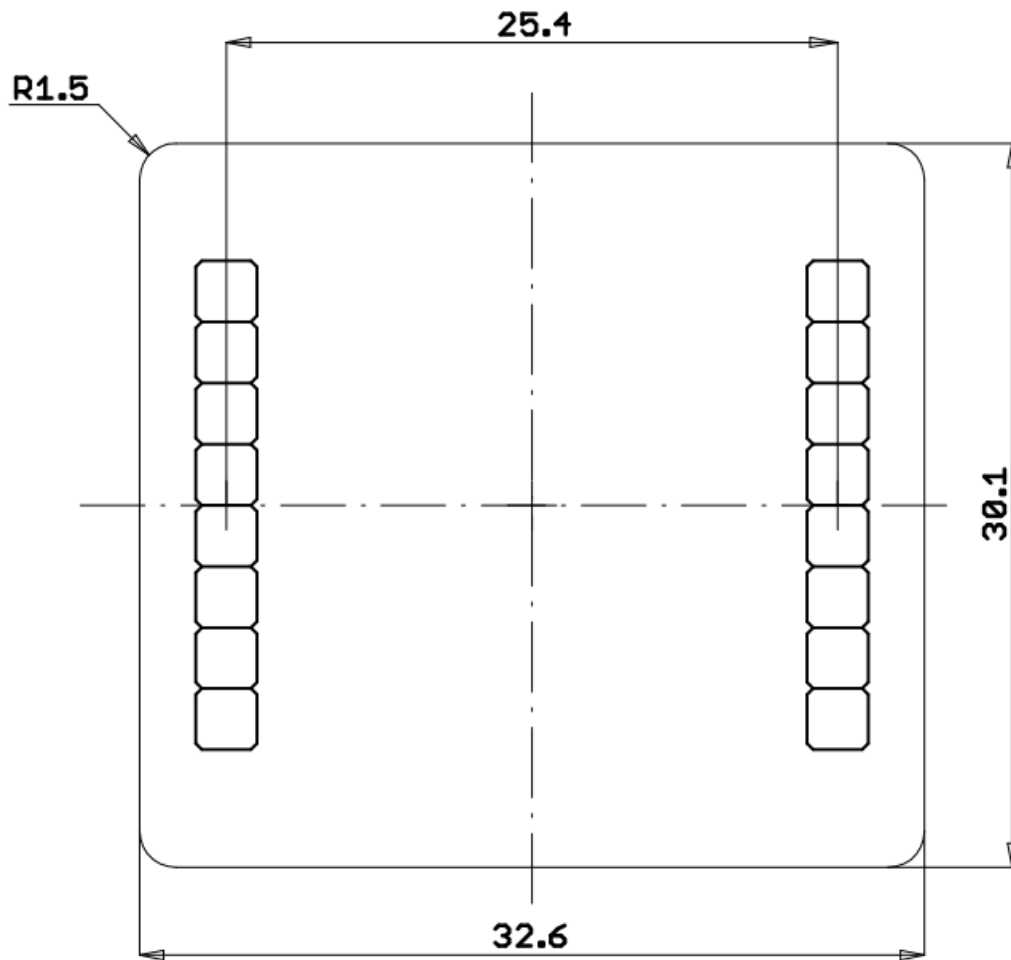
# 1 Introduction

TWN4 MultiTech Mini is a module to be integrated on custom PCB. It has a built-in HF antenna and subset of IOs compared to TWN4 Core Module. TWN4 Mini Reader is currently available as version TWN4 Mini Reader MIFARE NFC.



## 2 Dimensions

Below are the dimensions of the TWN4 MultiTech Mini. All dimensions in mm unless otherwise stated.



## 3 Connectors

The TWN4 Mini Reader has two on-board single row headers with 8 positions each. The pins of these two connectors are together enumerated from 1 to 16.

- Single row header
- Pitch 2.54mm
- Pin shape square 0.635mm

Pin	Pin Name	Function
1	RESET-	Low active TTL input with internal pull-up resistor for hard reset.
2	PWRDWN-	Low active TTL input with internal pull-up resistor for turning off the voltage regulator.
3	GND	Ground
4	VIN	Unregulated input to on-board voltage regulator
5	RXD- (USB: D+)	Low active TTL input with internal pull-up resistor of asynchronous RXD to COM1. In case of USB version: USB Data+
6	TXD- (USB: D-)	Low active TTL output (push/pull) of asynchronous TXD from COM1. In case of USB version: USB Data-
7	SCK	SCK from SPI host interface.
8	SS-	SS- from SPI host interface.
9	VCC	Internally regulated 3.0V power supply. To be used for SAM1.
10	SAM_IO	I/O line for SAM1.
11	GPIO3	GPIO3, I/O pin for general purposes.
12	GPIO2	GPIO2, I/O pin for general purposes.
13	GPIO1	GPIO1, I/O pin for general purposes.
14	GPIO0	GPIO0, I/O pin for general purposes.
15	SAM_CLK	Clock output for SAM1
16	SAM_RST	Reset output for SAM1

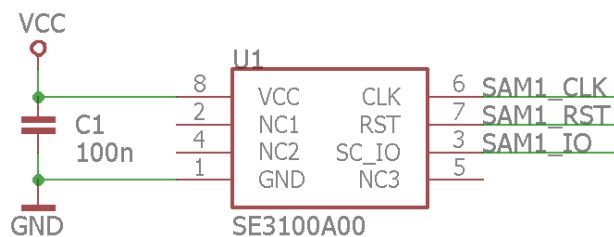
## 4 Using PI Option

To use the PI Option, e.g. to read the PAC bits from an iCLASS transponder, a SIO processor is needed. This can be either a SIO chip which is soldered directly on a PCB or a SAM card incorporating the SIO processor.

### 4.1 SIO Chip soldered on PCB

The SIO processor has to be added to the design of the mainboard. The chip shall be connected to the SAM-pins of the TWN4 Mini Reader.

Recommended schematic:



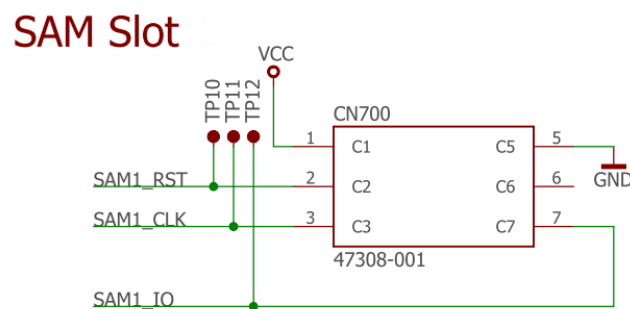
### 4.2 SAM Card Connection

A SAM socket has to be added to the design of the mainboard. The SAM socket shall be connected to the SAM-pins of the TWN4 Mini Reader.

Following SAM sockets are recommended:

- Molex 47388-2001
- Molex 47308-0001

Recommended schematic:



## 5 Disclaimer

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